

July 2010

# **GBPC 12, 15, 25, 35 SERIES Bridge Rectifiers (Glass Passivated)**

# **Features**

- · Integrally molded heatsink provided very low thermal resistance for maximum heat dissipation.
- Surge Overload Ratings from 300 amperes to 400 amperes.
- Isolated voltage from case to lead over 2500 volts.
- UL certified, UL #E326243
- Terminals Finish Material Silver (solderable per MIL-STD-202, Method 208 for the wire type GBPC-W package)
   Nickel for GBPC package.

### Suffix "W"

Wire Lead Structure

# Suffix "M"

Terminal Location Face to Face









# Absolute Maximum Ratings \* T<sub>A</sub> = 25°C unless otherwise noted

| Symbol             | Parameter  |  | Value       |     |     |             |     |        | Units |
|--------------------|--|--|-------------|-----|-----|-------------|-----|--------|-------|
|                    |  |  | 01          | 02  | 04  | 06          | 08  | 10     | Units |
| V <sub>RRM</sub>   | Maximum Repetitive Reverse Voltage   |  | 100         | 200 | 400 | 600         | 800 | 1000   | V     |
| V <sub>RMS</sub>   | Maximum RMS Bridge Input Voltage   |  | 70          | 140 | 280 | 420         | 560 | 700    | V     |
| $V_R$              | DC Reverse Voltage (Rated V <sub>R</sub> )   |  | 100         | 200 | 400 | 600         | 800 | 1000   | V     |
| I <sub>F(AV)</sub> | Average Rectified Forward Current  @ T <sub>C</sub> = 55°C   |  |             |     |     | A<br>A<br>A |     |        |       |
| I <sub>FSM</sub>   | Non-Repetitive Peak Forward Surge Current<br>GBPC12, 25, 25<br>8.3ms Single Half-Sine-Wave<br>GBPC35 |  |             |     |     |             |     | A<br>A |       |
| T <sub>STG</sub>   | Storage Temperature Range  |  | -55 to +150 |     |     |             |     | °C     |       |
| T <sub>J</sub>     | Operating Junction Temperature   |  | -55 to +150 |     |     |             |     | °C     |       |

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

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# **Thermal Characteristics**

| Symbol          | Parameter                              | Value | Units |  |
|-----------------|--|-------|-------|--|
| $P_{D}$         | Power Dissipation                      | 83.3  | W     |  |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case * | 1.5   | °C/W  |  |

<sup>\*</sup> With Heatsink

# **Electrical Characteristics** $T_A = 25$ °C unless otherwise noted

| Symbol           | Parameter  |   | Value                    | Units                                    |  |
|------------------|--|---|--------------------------|--|--|
| V <sub>F</sub>   | Forward Voltage Drop, per brid<br>@6.0A<br>@7.5A<br>@12.5A<br>@17.5A | GBPC12<br>GBPC15<br>GBPC25<br>GBPC35            | 1.1 (Max.)               | V  |  |
| I <sub>R</sub>   | Reverse Current, per element<br>@ Rated V <sub>R</sub>               | T <sub>A</sub> = 25°C<br>T <sub>A</sub> = 125°C | 5.0 (Max.)<br>500 (Max.) | μΑ<br>μΑ                                 |  |
| l <sup>2</sup> t | Rating for Fusing t < 8.35ms   | GBPC12, 15, 25<br>GBPC35                        | 375<br>660               | A <sup>2</sup> Sec<br>A <sup>2</sup> Sec |  |
| C <sub>T</sub>   | Total Capacitance, per leg $V_R = 4.0V$ $f = 1.0MHz$                 | GBPC12, 15, 25<br>GBPC35                        | 180<br>200               | pF<br>pF                                 |  |

# **Typical Performance Characteristics**

Figure 1. Forward Current Derating Curve

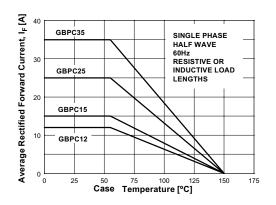


Figure 2. Non-Repetitive Surge Current

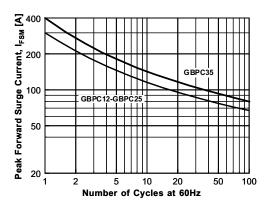


Figure 3. Forward Voltage Characteristics

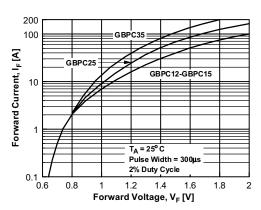
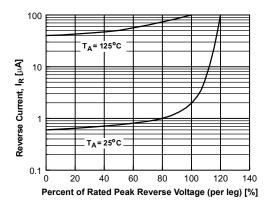


Figure 4. Reverse Current vs Reverse Voltage





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